# **MA3X786** (MA786)

## Silicon epitaxial planar type

For super-high speed switching circuit For small current rectification

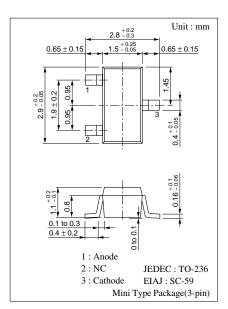
#### ■ Features

- Allowing to rectify under  $(I_{F(AV)} = 100 \text{ mA})$  condition
- Optimum for high-frequency rectification because of its short reverse recovery time (t<sub>rr</sub>)
- Low V<sub>F</sub> (forward rise voltage), with high rectification efficiency

## ■ Absolute Maximum Ratings $T_a = 25$ °C

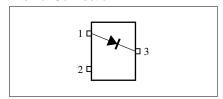
Parameter	Symbol	Rating	Unit
Reverse voltage (DC)	$V_R$	30	V
Repetitive peak reverse voltage	$V_{RRM}$	30	V
Peak forward current	$I_{FM}$	300	mA
Average forward current	I <sub>F(AV)</sub>	100	mA
Non-repetitive peak forward surge current*	$I_{FSM}$	1	A
Junction temperature	$T_{j}$	125	°C
Storage temperature	$T_{stg}$	-55 to +125	°C

Note) \* : The peak-to-peak value in one cycle of 50 Hz sine-wave (non-repetitive)



Marking Symbol: M3T

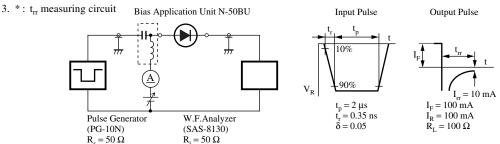
#### Internal Connection



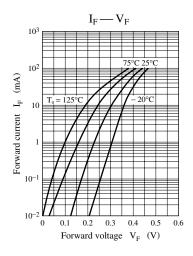
### ■ Electrical Characteristics $T_a = 25$ °C

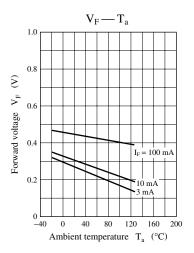
Parameter	Symbol	Conditions	Min	Typ	Max	Unit
Reverse current (DC)	$I_R$	$V_R = 30 \text{ V}$			15	μΑ
Forward voltage (DC)	V <sub>F</sub>	$I_F = 100 \text{ mA}$			0.55	V
Terminal capacitance	$C_{t}$	$V_R = 0 \text{ V, f} = 1 \text{ MHz}$		20		pF
Reverse recovery time*	t <sub>rr</sub>	$I_F = I_R = 100 \text{ mA}$		2		ns
		$I_{rr} = 10 \text{ mA}, R_{L} = 100 \Omega$				

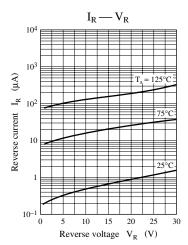
- Note) 1. Schottky barrier diode is sensitive to electric shock (static electricity, etc.). Due attention must be paid on the charge of a human body and the leakage of current from the operating equipment.
  - 2. Rated input/output frequency: 250 MHz

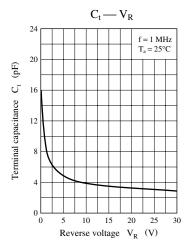


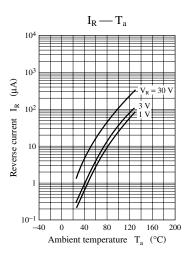
Note) The part number in the parenthesis shows conventional part number.











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